Microchip Technology - ATF20V8B-15JC Datasheet

Understanding Embedded - PLDs (Programmable Logic Devices)

Embedded - PLDs, or Programmable Logic Devices, are a type of digital electronic component used to build reconfigurable digital circuits. Unlike fixed-function logic devices, PLDs can be programmed to perform specific functions by the user. This flexibility allows designers to customize the logic to meet the exact needs of their applications, making PLDs a crucial component in modern embedded systems.

Applications of Embedded - PLDs (Programmable Logic Devices)

The versatility of PLDs makes them suitable for a wide range of applications. In consumer electronics, PLDs are used to enhance the functionality and performance of

Details	
Product Status	Obsolete
Programmable Type	EE PLD
Number of Macrocells	8
Voltage - Input	5V
Speed	15 ns
Mounting Type	Surface Mount
Package / Case	28-LCC (J-Lead)
Supplier Device Package	28-PLCC (11.51x11.51)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf20v8b-15jc

Description

The ATF20V8B is a high-performance CMOS (electrically-erasable) programmable logic device (PLD) that utilizes Atmel's proven electrically-erasable Flash memory technology. Speeds down to 7.5 ns and power dissipation as low as 10 mA are offered. All speed ranges are specified over the full 5V ± 10% range for industrial temperature ranges, and 5V ± 5% for commercial temperature ranges.

Several low-power options allow selection of the best solution for various types of power-limited applications. Each of these options significantly reduces total system power and enhances system reliability.

The ATF20V8Bs incorporate a superset of the generic architectures, which allows direct replacement of the 20R8 family and most 24-pin combinatorial PLDs. Eight outputs are each allocated eight product terms. Three different modes of operation, configured automatically with software, allow highly complex logic functions to be realized.

Absolute Maximum Ratings*

Temperature Under Bias................................. -55°C to +125°C

Storage Temperature .... -65°C to +150°C

Voltage on Any Pin with
Respect to Ground ....-2.0V to +7.0V[1]

Voltage on Input Pins
with Respect to Ground
During Programming.....................................-2.0V to +14.0V[1]

Programming Voltage with
Respect to Ground ....-2.0V to +14.0V[1]

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V_{CC} + 0.75V DC which may overshoot to 7.0V for pulses of less than 20 ns.

DC and AC Operating Conditions

	Commercial	Industrial
Operating Temperature (Ambient)	0°C - 70°C	-40°C - 85°C
V_{CC} Power Supply	5V ± 5%	5V ± 10%

DC Characteristics

Symbol	Parameter	Condition			Min	Typ	Max	Units
I_{IL}	Input or I/O Low Leakage Current	$0 \leq V_{IN} \leq V_{IL}(Max)$				-35	-100	µA
I_{IH}	Input or I/O High Leakage Current	$3.5 \leq V_{IN} \leq V_{CC}$					10	µA
I_{CC}	Power Supply Current, Standby	V_{CC} = Max, V_{IN} = Max, Outputs Open	B-7, -10	Com.		60	90	mA
				Ind.		60	100	mA
			B-15	Com.		60	80	mA
			B-15	Ind.		60	90	mA
			B-25	Com.		60	80	mA
			B-25	Ind.		60	90	mA
			BQ-10	Com.		35	55	mA
			BQL-15	Com.		5	10	mA
			BQL-15	Ind.		5	15	mA
			BQL-25	Com.		5	10	mA
			BQL-25	Ind.		5	15	mA
I_{CC2}	Clocked Power Supply Current	V_{CC} = Max, Outputs Open, f = 15 MHz	B-7, -10	Com.		80	110	mA
				Ind.		80	125	mA
			B-15	Com.		60	90	mA
			B-15	Ind.		60	105	mA
			B-25	Com.		60	90	mA
			B-25	Ind.		60	105	mA
			BQ-10	Com.		40	55	mA
			BQL-15	Com.		20	35	mA
			BQL-15	Ind.		20	40	mA
			BQL-25	Com.		20	35	mA
			BQL-25	Ind.		20	40	mA
$IOS^{(1)}$	Output Short Circuit Current	V_{OUT} = 0.5V					-130	mA
V_{IL}	Input Low Voltage				-0.5		0.8	V
V_{IH}	Input High Voltage				2.0		V_{CC} + 0.75	V
V_{OL}	Output Low Voltage	$V_{IN} = V_{IH}$ or V_{IL}, V_{CC} = Min	I_{OL} = 24 mA	Com., Ind.			0.5	V
			I_{OL} = 16 mA				0.5	V
V_{OH}	Output High Voltage	$V_{IN} = V_{IH}$ or V_{IL}, V_{CC} = Min	I_{OH} = -4.0 mA		2.4			V

Notes: 1. Not more than one output at a time should be shorted. Duration of short circuit test should not exceed 30 sec.

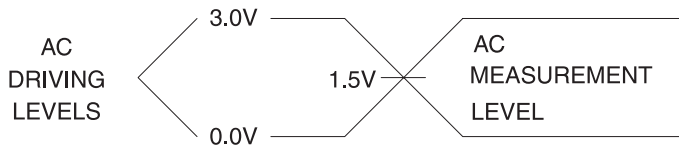2. Shaded parts are obsolete with a last time buy date of 19 August 1999.

AC Waveforms[1]
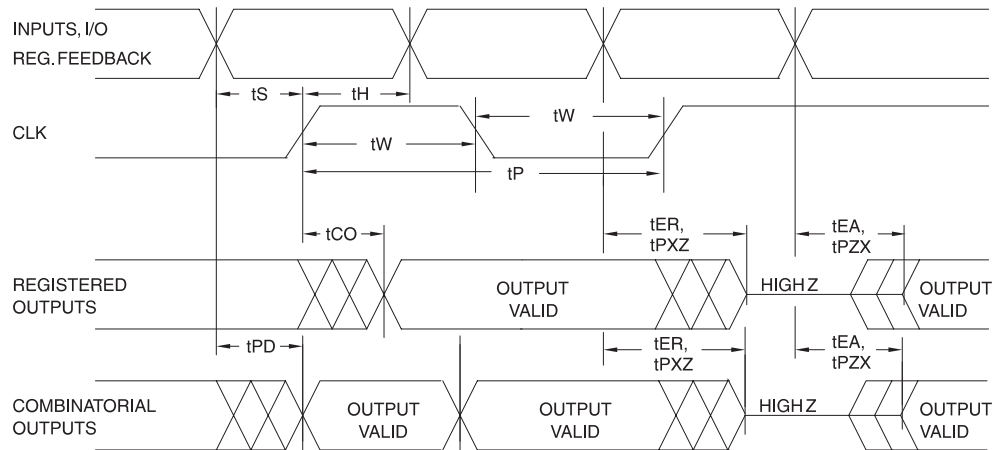
Note: 1. Timing measurement reference is 1.5V. Input AC driving levels are 0.0V and 3.0V, unless otherwise specified.

AC Characteristics[1]

Symbol	Parameter		-7		-10		-15		-25		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD}	Input or Feedback to Non-Registered Output	8 outputs switching	3	7.5	3	10	3	15	3	25	ns
		1 output switching		7							ns
t_{CF}	Clock to Feedback			3		6		8		10	ns
t_{CO}	Clock to Output		2	5	2	7	2	10	2	12	ns
t_S	Input or Feedback Setup Time		5		7.5		12		15		ns
t_H	Hold Time		0		0		0		0		ns
t_P	Clock Period		8		12		16		24		ns
t_W	Clock Width		4		6		8		12		ns
f_{MAX}	External Feedback $1/(t_S + t_{CO})$			100		68		45		37	MHz
	Internal Feedback $1/(t_S + t_{CF})$			125		74		50		40	MHz
	No Feedback $1/(t_P)$			125		83		62		41	MHz
t_{EA}	Input to Output Enable — Product Term		3	9	3	10	3	15	3	20	ns
t_{ER}	Input to Output Disable —Product Term		2	9	2	10	2	15	2	20	ns
t_{PZX}	$\overline{OE}$ pin to Output Enable		2	6	2	10	2	15	2	20	ns
t_{PXZ}	$\overline{OE}$ pin to Output Disable		1.5	6	1.5	10	1.5	15	1.5	20	ns

Note: 1. See ordering information for valid part numbers and speed grades.

2. Shaded -25 parts are obsolete with a last-time buy date of August 19, 1999.

3. Shaded -7 and -15 parts are obsolete with a last-time buy date of September 30, 2006.

Input Test Waveforms and Measurement Levels

AC DRIVING LEVELS

3.0V

1.5V

0.0V

AC MEASUREMENT LEVEL

t_R, t_F < 5 ns (10% to 90%)

Output Test Loads

Commercial

5.0V

R1 = 200

R2 = 390

OUTPUT PIN

CL = 50 pF

Pin Capacitance

f = 1 MHz, T = 25°C[1]

	Typ	Max	Units	Conditions
C_{IN}	5	8	pF	V_{IN} = 0V
C_{OUT}	6	8	pF	V_{OUT} = 0V

Note: 1.   Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

Power-up Reset

The registers in the ATF20V8Bs are designed to reset during power-up. At a point delayed slightly from V_{CC} crossing V_{RST}, all registers will be reset to the low state. As a result, the registered output state will always be high on power-up.

This feature is critical for state machine initialization. However, due to the asynchronous nature of reset and the uncertainty of how V_{CC} actually rises in the system, the following conditions are required:

1.   The V_{CC} rise must be monotonic,
2.   After reset occurs, all input and feedback setup times must be met before driving the clock pin high, and
3.   The clock must remain stable during t_{PR}.

POWER

V_{RST}

t_{PR}

REGISTERED OUTPUTS

t_S

CLOCK

t_W
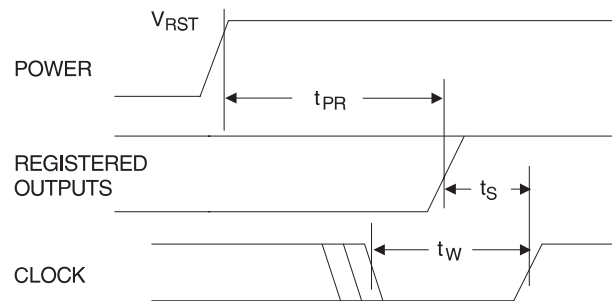
Parameter	Description	Typ	Max	Units
t_{PR}	Power-up Reset Time	600	1,000	ns
V_{RST}	Power-up Reset Voltage	3.8	4.5	V

Preload of Registered Outputs

The ATF16V8B's registers are provided with circuitry to allow loading of each register with either a high or a low. This feature will simplify testing since any state can be forced into the registers to control test sequencing. A JEDEC file with preload is generated when a source file with vectors is compiled. Once downloaded, the JEDEC file preload sequence will be done automatically by most of the approved programmers after the programming.

Electronic Signature Word

There are 64 bits of programmable memory that are always available to the user, even if the device is secured. These bits can be used for user-specific data.

Security Fuse Usage

A single fuse is provided to prevent unauthorized copying of the ATF20V8B fuse patterns. Once programmed, fuse verify and preload are inhibited. However, the 64-bit User Signature remains accessible.

The security fuse should be programmed last, as its effect is immediate.

Programming/Erasing

Programming/erasing is performed using standard PLD programmers. For further information, see the Configurable Logic Databook, section titled, "CMOS PLD Programming Hardware and Software Support."

Input and I/O Pull-ups

All ATF20V8B family members have internal input and I/O pull-up resistors. Therefore, whenever inputs or I/Os are not being driven externally, they will float to V_{CC}. This ensures that all logic array inputs are at known states.

These are relatively weak active pull-ups that can easily be overdriven by TTL-compatible drivers (see input and I/O diagrams below).

Input Diagram
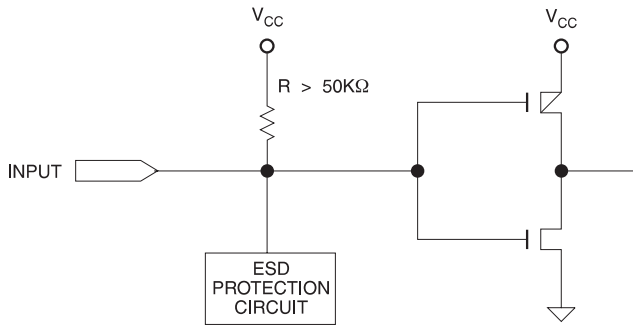
I/O Diagram
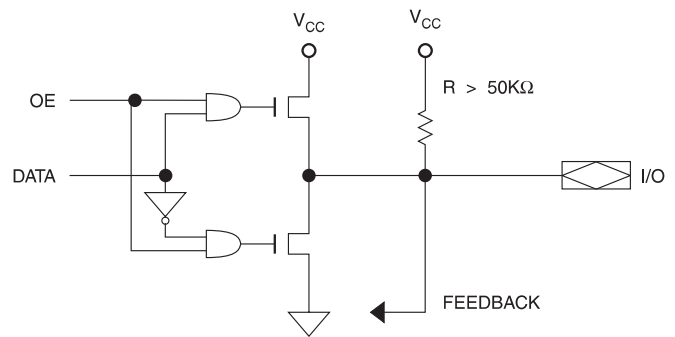
Functional Logic Diagram Description

The Logic Option and Functional Diagrams describe the ATF20V8B architecture. Eight configurable macrocells can be configured as a registered output, combinatorial I/O, combinatorial output, or dedicated input.

The ATF20V8B can be configured in one of three different modes. Each mode makes the ATF20V8B look like a different device. Most PLD compilers can choose the right mode automatically. The user can also force the selection by supplying the compiler with a mode selection. The determining factors would be the usage of register versus combinatorial outputs and dedicated outputs versus outputs with output enable control.

The ATF20V8B universal architecture can be programmed to emulate many 24-pin PAL devices. These architectural

subsets can be found in each of the configuration modes described in the following pages. The user can download the listed subset device JEDEC programming file to the PLD programmer, and the ATF20V8B can be configured to act like the chosen device. Check with your programmer manufacturer for this capability.

Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the content of the ATF20V8B. Eight bytes (64 fuses) of User Signature are accessible to the user for purposes such as storing project name, part number, revision, or date. The User Signature is accessible regardless of the state of the security fuse.

ATF20V8B(Q)(L)

Compiler Mode Selection

	Registered	Complex	Simple	Auto Select
ABEL, Atmel-ABEL	P20V8R	P20V8C	P20V8	P20V8
CUPL	G20V8MS	G20V8MA	G20V8	G20V8A
LOG/iC	GAL20V8_R[1]	GAL20V8_C7[1]	GAL20V8_C8[1]	GAL20V8
OrCAD-PLD	"Registered"	"Complex"	"Simple"	GAL20V8
PLDesigner	P20V8	P20V8	P20V8	P20V8
Tango-PLD	G20V8	G20V8	G20V8	G20V8

Note: 1. Only applicable for version 3.4 or lower.

ATF20V8B Registered Mode

PAL Device Emulation/PAL Replacement. The registered mode is used if one or more registers are required. Each macrocell can be configured as either a registered or combinatorial output or I/O, or as an input. For a registered output or I/O, the output is enabled by the $\overline{OE}$ pin, and the register is clocked by the CLK pin. Eight product terms are allocated to the sum term. For a combinatorial output or I/O, the output enable is controlled by a product term, and seven product terms are allocated to the sum term. When the macrocell is configured as an input, the output enable is permanently disabled.

Any register usage will make the compiler select this mode. The following registered devices can be emulated using this mode:

20R8	20RP8
20R6	20RP6
20R4	20RP4

Registered Mode Operation
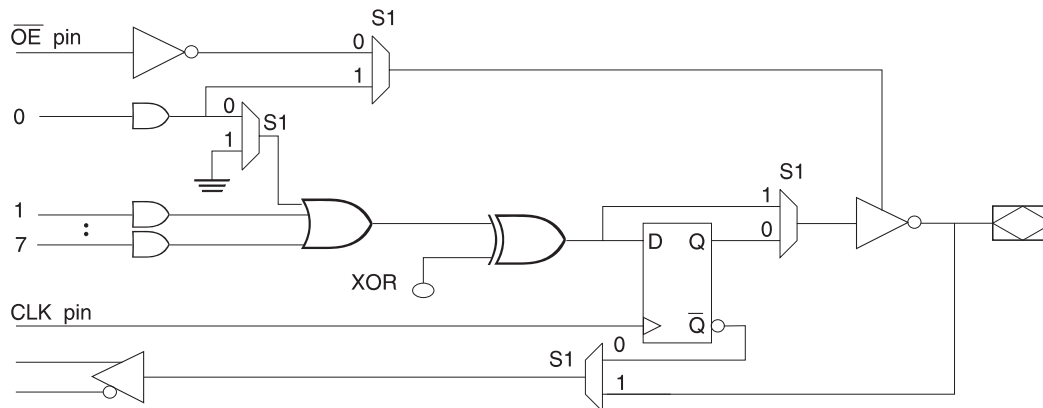
Registered Mode Logic Diagram
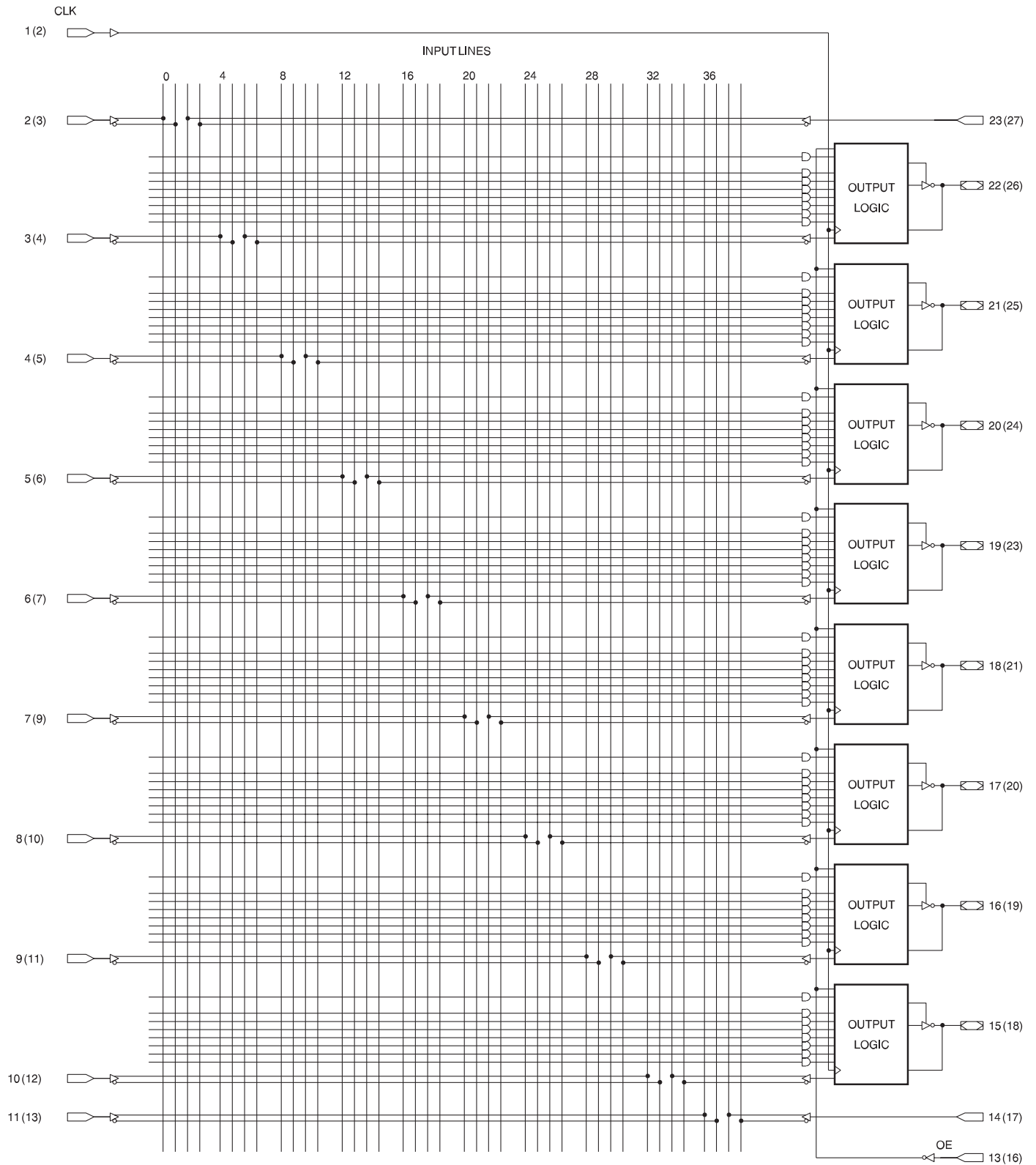
ATF20V8B(Q)(L)

ATF20V8B Complex Mode

PAL Device Emulation/PAL Replacement. In the complex Mode, combinatorial output and I/O functions are possible. Pins 1 and 11 are regular inputs to the array. Pins 13 through 18 have pin feedback paths back to the AND-array, which makes full I/O capability possible. Pins 12 and 19 (outermost macrocells) are outputs only. They do not have input capability. In this mode, each macrocell has seven product terms going to the sum term and one product term enabling the output.

Combinatorial applications with an OE requirement will make the compiler select this mode. The following devices can be emulated using this mode:

20L8

20H8

20P8

Complex Mode Operation

Pins 15 and 22 do not have this feedback path.
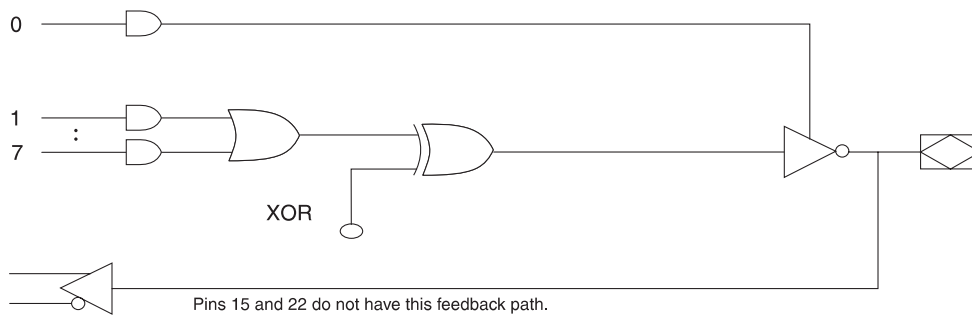
ATF20V8B Simple Mode

PAL Device Emulation/PAL Replacement. In the Simple Mode, 8 product terms are allocated to the sum term. Pins 15 and 16 (center macrocells) are permanently configured as combinatorial outputs. Other macrocells can be either inputs or combinatorial outputs with pin feedback to the AND-array. Pins 1 and 11 are regular inputs.

The compiler selects this mode when all outputs are combinatorial without OE control. The following simple PALs can be emulated using this mode:

14L8	14H8	14P8
16L6	18H6	16P6
18L4	18H4	18P4
20L2	20H2	20P2

Simple Mode Option

Pins 18 and 19 do not have this feedback path.
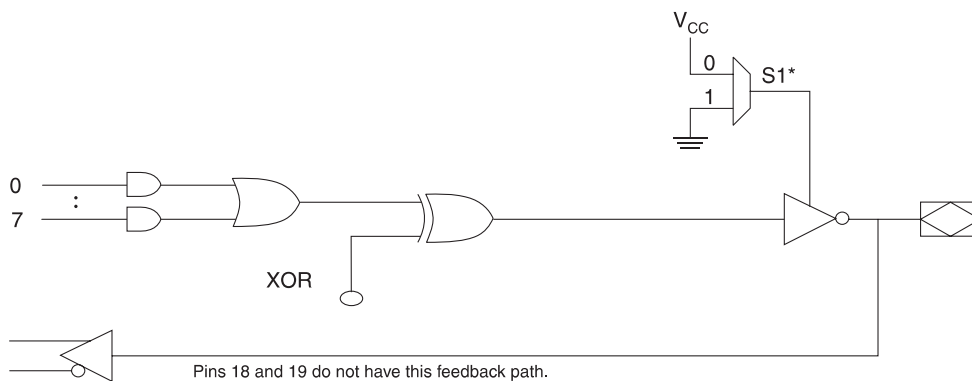
* - Pins 18 and 19 are always enabled.

Complex Mode Logic Diagram
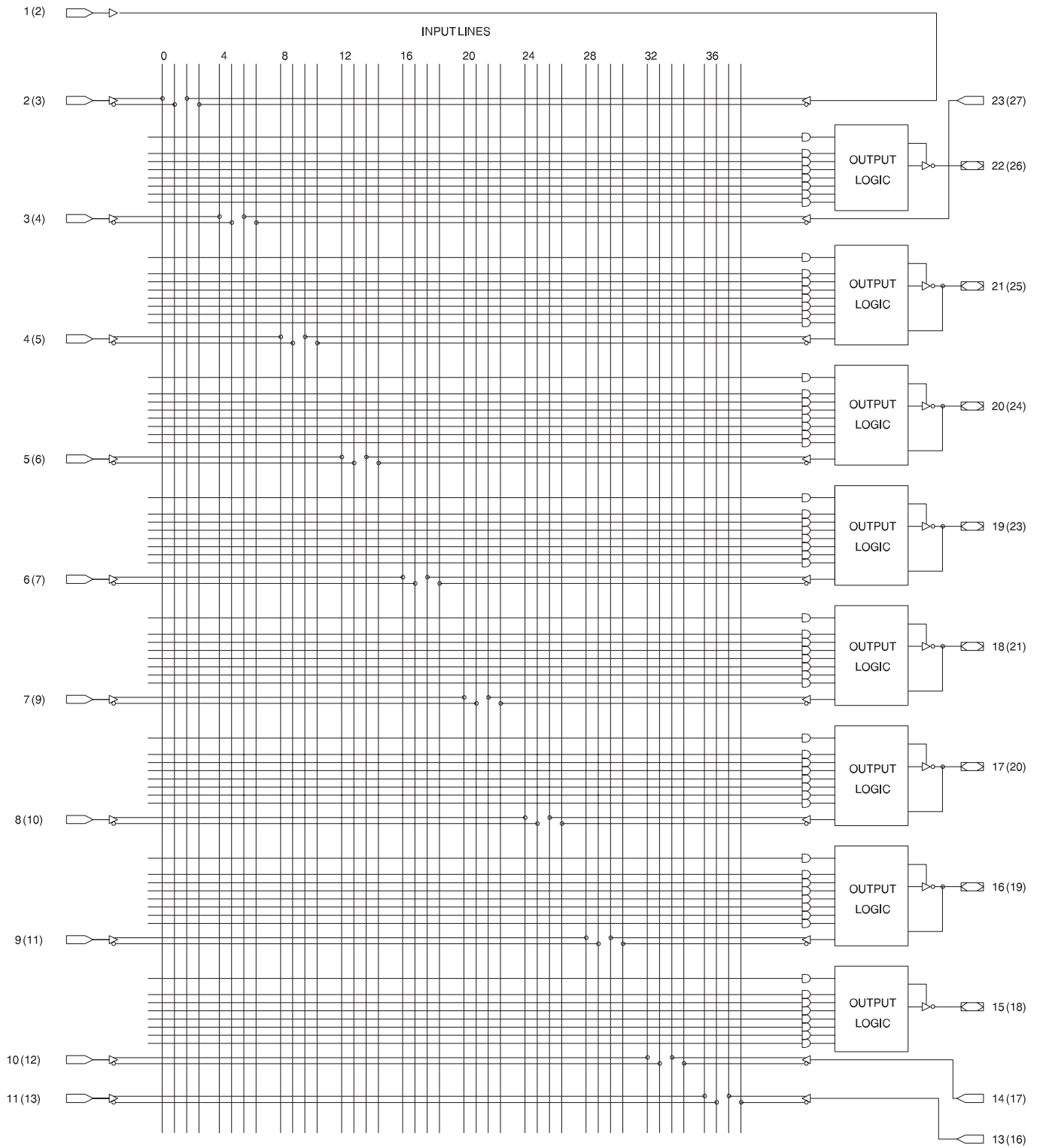
Simple Mode Logic Diagram
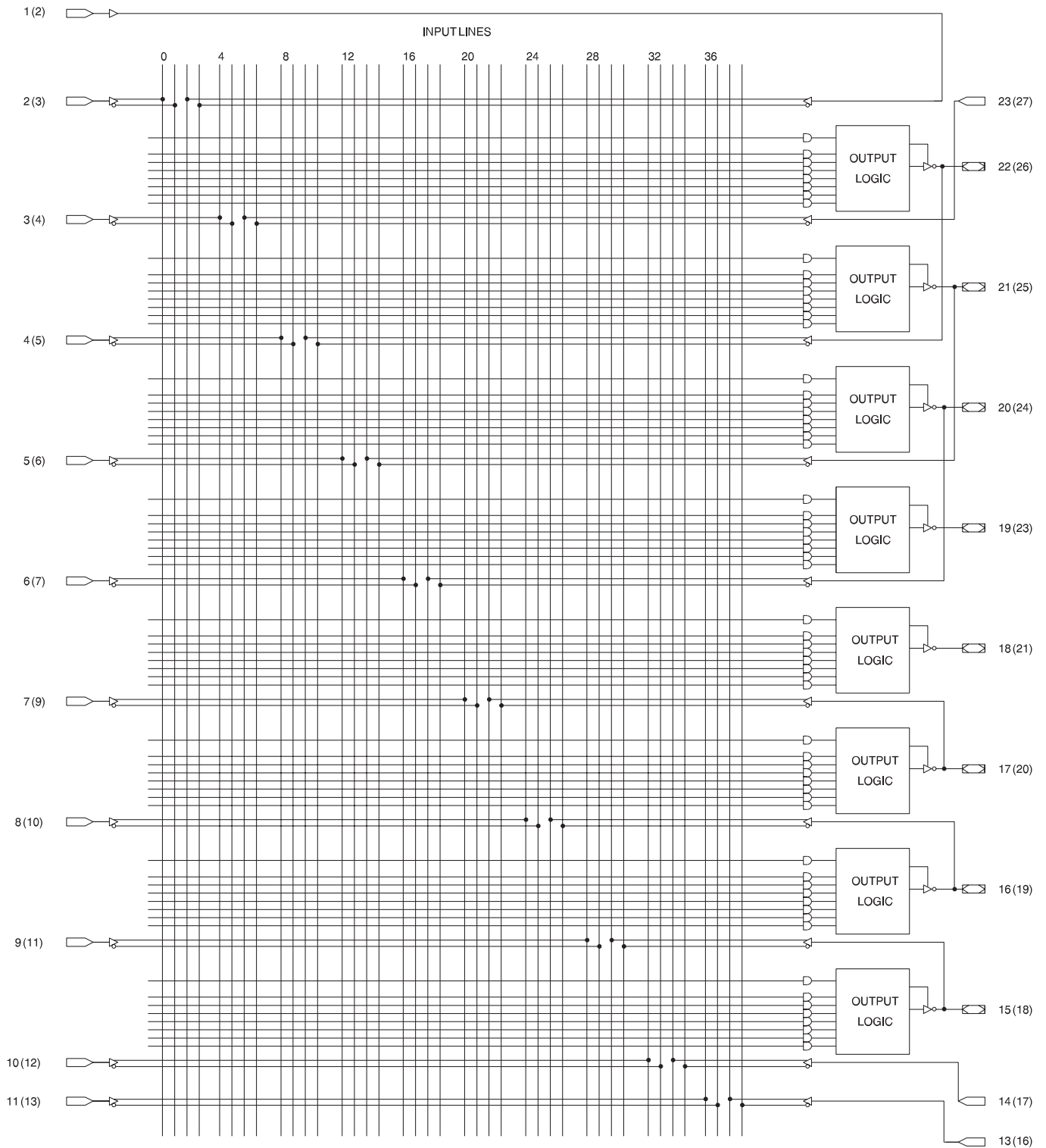
SUPPLY CURRENT vs. INPUT FREQUENCY
ATF20V8B/BQ (VCC=5V, TA=25°C)
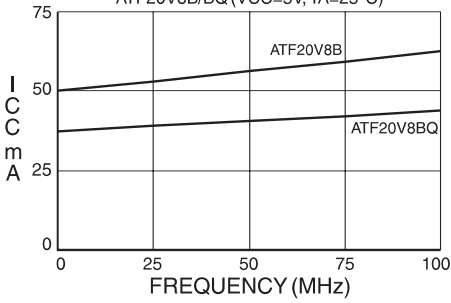
SUPPLY CURRENT vs. INPUT FREQUENCY
ATF20V8BQL (VCC = 5V, TA = 25°C)
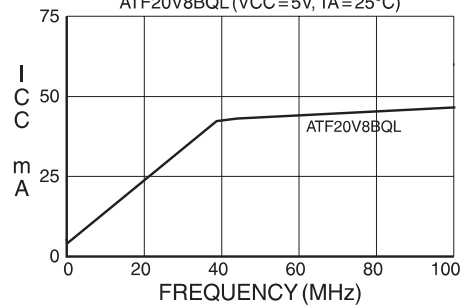
SUPPLY CURRENT vs. SUPPLY VOLTAGE
ATF20V8B/BQ (TA = 25°C)
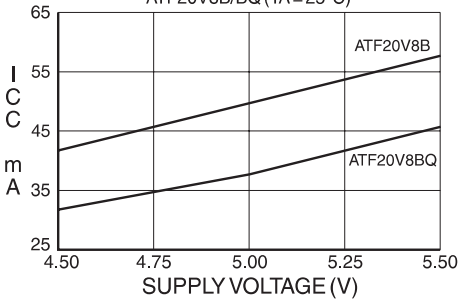
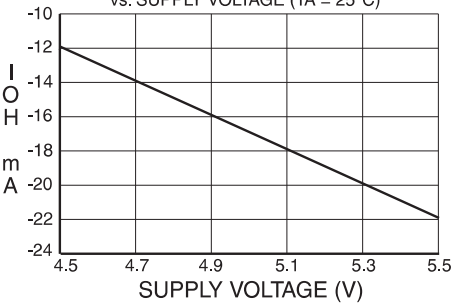### SUPPLY CURRENT vs. SUPPLY VOLTAGE
ATF20V8BL/BQL (TA = 25°C)
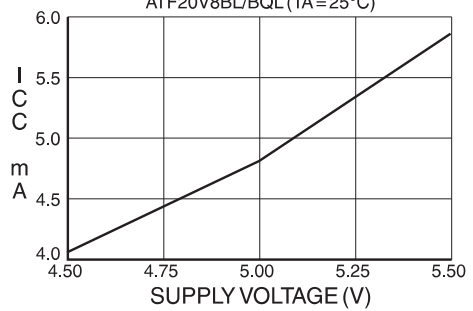
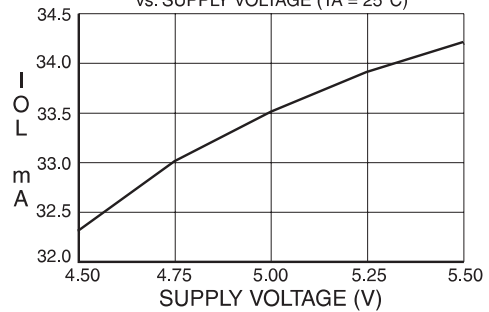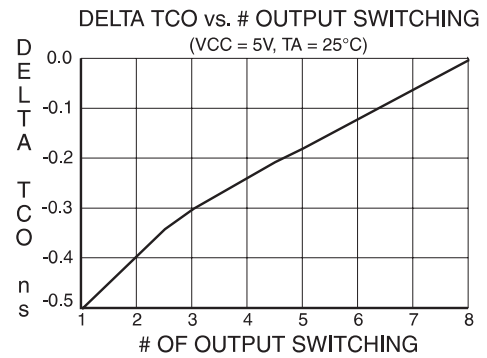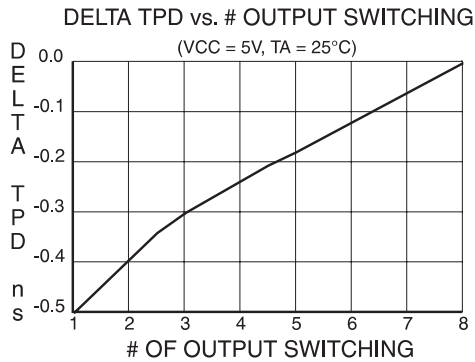### SUPPLY CURRENT vs. AMBIENT TEMPERATURE
ATF20V8B/BQ (VCC = 5V)
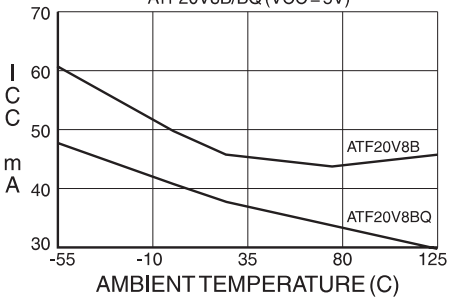
SUPPLY CURRENT vs. AMBIENT TEMPERATURE
ATF20V8BL/BQL (VCC = 5V)
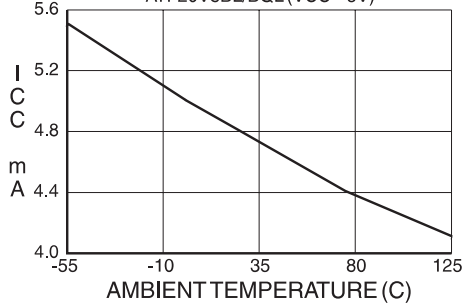
OUTPUT SOURCE CURRENT
vs. SUPPLY VOLTAGE (TA = 25°C)

OUTPUT SINK CURRENT
vs. SUPPLY VOLTAGE (TA = 25°C)

NORMALIZED TS
vs. SUPPLY VOLTAGE (TA = 25°C)

NORMALIZED TS
vs. AMBIENT TEMPERATURE (VCC = 5V)

DELTA TPD vs. OUTPUT LOADING
(VCC = 5V, TA = 25°C)

DELTA TCO vs. OUTPUT LOADING
(VCC = 5V, TA = 25°C)

DELTA TPD vs. # OUTPUT SWITCHING
(VCC = 5V, TA = 25°C)

DELTA TCO vs. # OUTPUT SWITCHING
(VCC = 5V, TA = 25°C)

INPUT CURRENT vs. INPUT VOLTAGE
(VCC = 5V, TA = 25°C)

INPUT CLAMP CURRENT
vs. INPUT VOLTAGE (VCC = 5V, TA = 25°C)
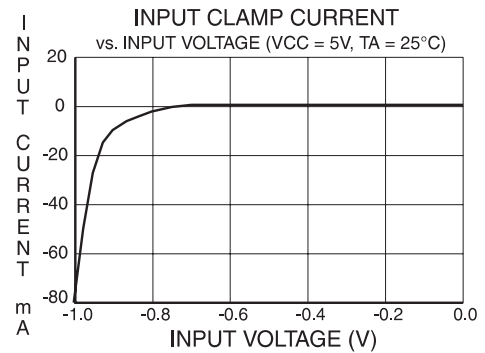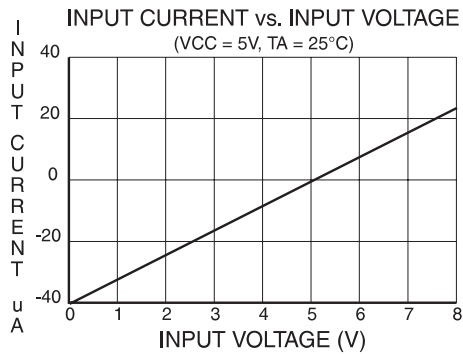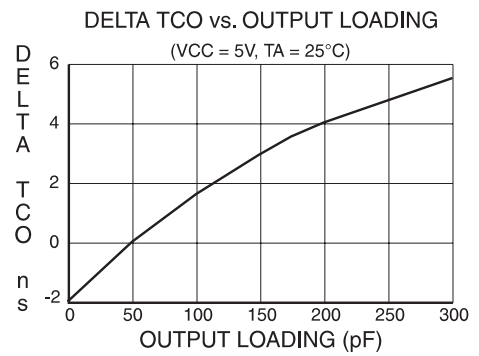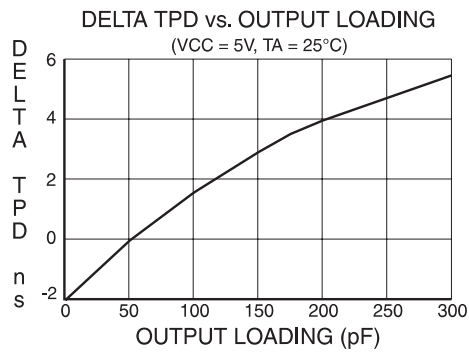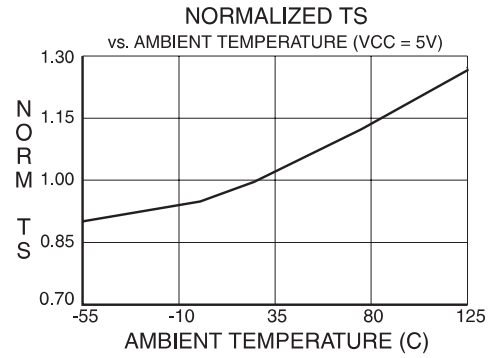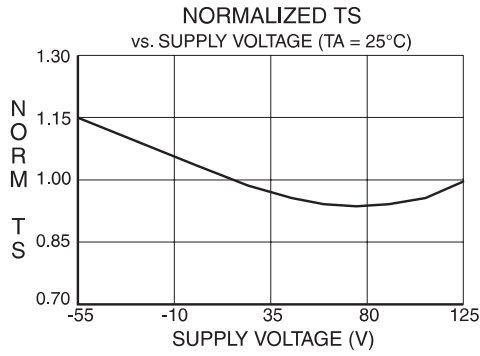
ATF20V8B Ordering Information

t$_{PD}$ (ns)	t$_S$ (ns)	t$_{CO}$ (ns)	Ordering Code	Package	Operation Range
7.5	5	5	ATF20V8B-7JC ATF20V8B-7PC ATF20V8B-7SC ATF20V8B-7XC	28J 24P3 24S 24X	Commercial (0°C to 70°C)
10	7.5	7	ATF20V8B-10JC ATF20V8B-10PC ATF20V8B-10SC ATF20V8B-10XC	28J 24P3 24S 24X	Commercial (0°C to 70°C)
			ATF20V8B-10JI ATF20V8B-10PI ATF20V8B-10SI ATF20V8B-10XI	28J 24P3 24S 24X	Industrial (-40°C to 85°C)
15	12	10	ATF20V8B-15JC ATF20V8B-15PC ATF20V8B-15SC ATF20V8B-15XC	28J 24P3 24S 24X	Commercial (0°C to 70°C)
			ATF20V8B-15JI ATF20V8B-15PI ATF20V8B-15SI ATF20V8B-15XI	28J 24P3 24S 24X	Industrial (-40°C to 85°C)

Note: 1. Shaded parts are obsolete with a last-time buy date of September 30, 2006.

ATF20V8B Green Package Options (Pb/Halide-free/RoHS Compliant)

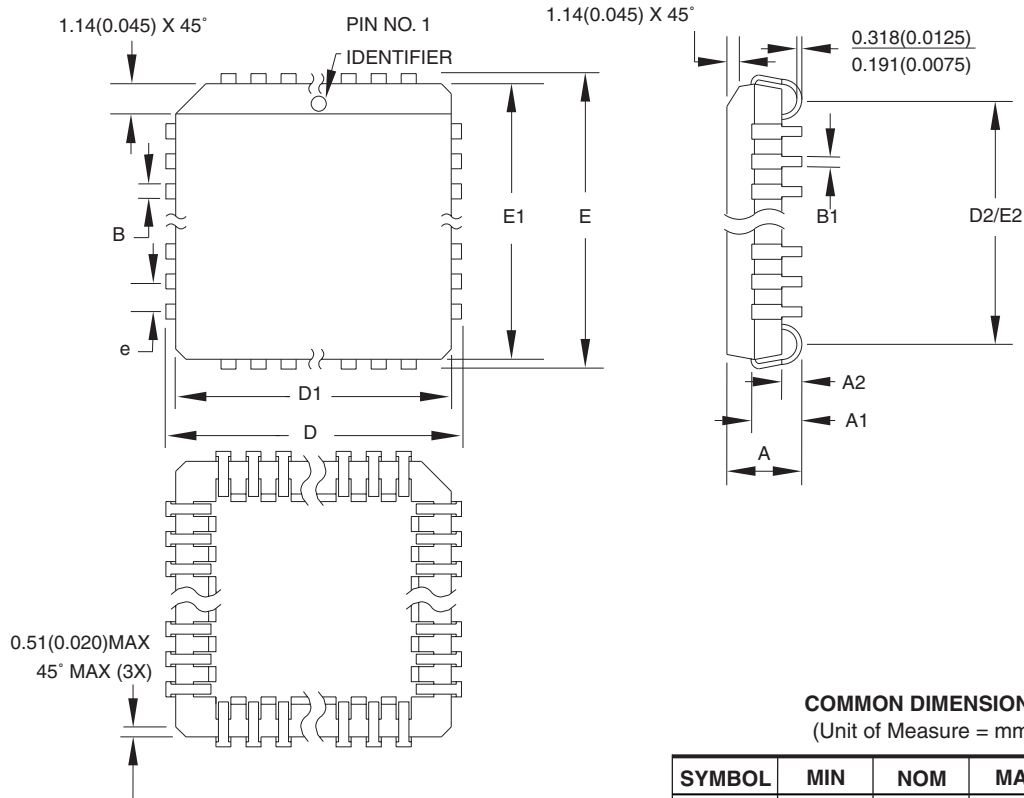| t$_{PD}$ (ns)	t$_S$ (ns)	t$_{CO}$ (ns)	Ordering Code	Package	Operation Range
10	7.5	7	ATF20V8B-10JU ATF20V8B-10PU	28J 24P3	Industrial (-40°C to 85°C)

Using "C" Product for Industrial

To use commercial product for Industrial temperature ranges, down-grade one speed grade from the "I" to the "C" device (7 ns "C" = 10 ns "I") and de-rate power by 30%.

Package Type	
28J	28-lead, Plastic J-leaded Chip Carrier (PLCC)
24P3	24-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
24S	24-lead, 0.300" Wide, Plastic Gull-wing Small Outline (SOIC)
24X	24-lead, 4.4 mm Wide, Plastic Thin Shrink Small Outline (TSSOP)

ATF20V8BQ and ATF20V8BQL Ordering Information

t_{PD} (ns)	t_S (ns)	t_{CO} (ns)	Ordering Code	Package	Operation Range
10	7.5	7	ATF20V8BQ-10JC ATF20V8BQ-10PC ATF20V8BQ-10XC	28J 24P3 24X	Commercial (0°C to 70°C)
15	12	10	ATF20V8BQL-15JC ATF20V8BQL-15PC ATF20V8BQL-15SC ATF20V8BQL-15XC	28J 24P3 24S 24X	Commercial (0°C to 70°C)
15	12	10	ATF20V8BQL-15JI ATF20V8BQL-15PI ATF20V8BQL-15SI ATF20V8BQL-15XI	28J 24P3 24S 24X	Industrial (-40°C to 85°C))

Note: 1.   Shaded parts are obsolete with a last-time buy date of September 30, 2006.

ATF20V8BQL Green Package Options (Pb/Halide-free/RoHS Compliant)

t_{PD} (ns)	t_S (ns)	t_{CO} (ns)	Ordering Code	Package	Operation Range
15	12	10	ATF20V8BQL-15JU ATF20V8BQL-15PU	28J 24P3	Industrial (-40°C to 85°C))

Note: 1.   Shaded parts are obsolete with a last-time buy date of September 30, 2006.

Using "C" Product for Industrial

To use commercial product for Industrial temperature ranges, down-grade one speed grade from the "I" to the "C" device (7 ns "C" = 10 ns "I") and de-rate power by 30%.

Package Type	
28J	28-lead, Plastic J-leaded Chip Carrier (PLCC)
24P3	24-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
24S	24-lead, 0.300" Wide, Plastic Gull-wing Small Outline (SOIC)
24X	24-lead, 4.4 mm Wide, Plastic Thin Shrink Small Outline (TSSOP)

Packaging Information

28J – PLCC

1.14(0.045) X 45°

PIN NO. 1
IDENTIFIER

1.14(0.045) X 45°

0.318(0.0125)
0.191(0.0075)

B

e

B1

D2/E2

E1　E

D1

D

A2

A1

A

0.51(0.020)MAX
45° MAX (3X)

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	–	4.572	
A1	2.286	–	3.048	
A2	0.508	–	–	
D	12.319	–	12.573	
D1	11.430	–	11.582	Note 2
E	12.319	–	12.573	
E1	11.430	–	11.582	Note 2
D2/E2	9.906	–	10.922	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes:　1. This package conforms to JEDEC reference MS-018, Variation AB.
　　　　2. Dimensions D1 and E1 do not include mold protrusion.
　　　　　Allowable protrusion is .010"(0.254 mm) per side. Dimension D1
　　　　　and E1 include mold mismatch and are measured at the extreme
　　　　　material condition at the upper or lower parting line.
　　　　3. Lead coplanarity is 0.004" (0.102 mm) maximum.

10/04/01

	TITLE	DRAWING NO.	REV.
AImEL 2325 Orchard Parkway San Jose, CA 95131	**28J**, 28-lead, Plastic J-leaded Chip Carrier (PLCC)	28J	B

24P3 – PDIP

Notes:
1. This package conforms to JEDEC reference MS-001, Variation AF.
2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	5.334	
A1	0.381	–	–	
D	31.623	–	32.131	Note 2
E	7.620	–	8.255	
E1	6.096	–	7.112	Note 2
B	0.356	–	0.559	
B1	1.270	–	1.651	
L	2.921	–	3.810	
C	0.203	–	0.356	
eB	–	–	10.922	
eC	0.000	–	1.524	
e	2.540 TYP			

6/1/04

	TITLE	DRAWING NO.	REV.
AIMEL 2325 Orchard Parkway San Jose, CA 95131	**24P3**, 24-lead (0.300"/7.62 mm Wide) Plastic Dual Inline Package (PDIP)	24P3	D

ATF20V8B(Q)(L)

24S – SOIC
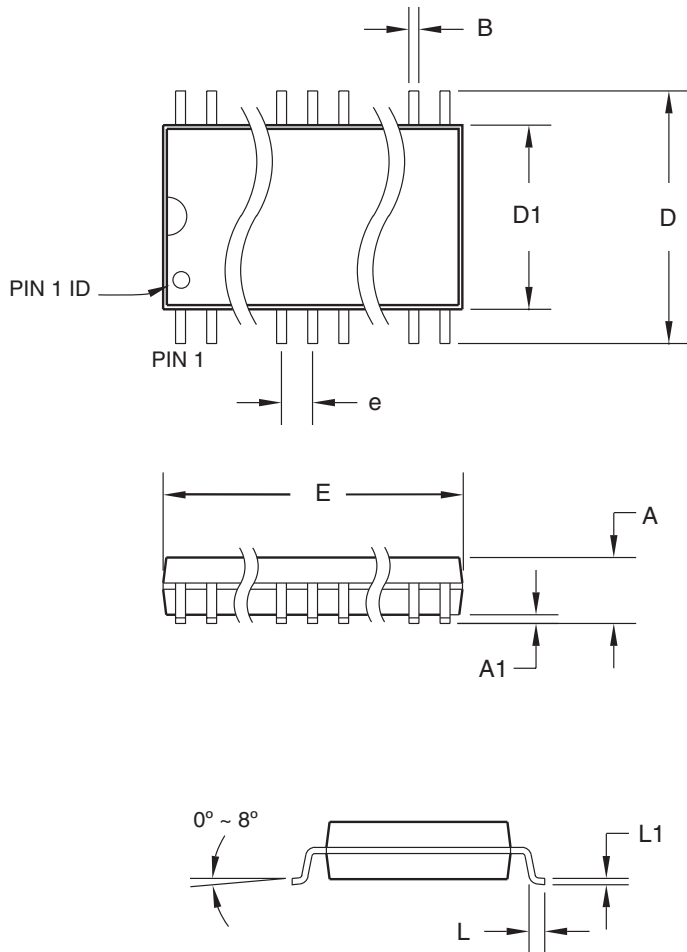
COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	2.65	
A1	0.10	–	0.30	
D	10.00	–	10.65	
D1	7.40	–	7.60	
E	15.20	–	15.60	
B	0.33	–	0.51	
L	0.40	–	1.27	
L1	0.23	–	0.32	
e		1.27 BSC		

06/17/2002

	2325 Orchard Parkway San Jose, CA 95131	**TITLE** **24S**, 24-lead (0.300" body) Plastic Gull Wing Small Outline (SOIC)	**DRAWING NO.** 24S	**REV.** B

24X – TSSOP

Dimensions in Millimeter and (Inches)*
JEDEC STANDARD MO-153 AD
Controlling dimension: millimeters

$\dfrac{0.30(0.012)}{0.19(0.007)}$

$\dfrac{4.48(0.176)}{4.30(0.169)}$ $\dfrac{6.50(0.256)}{6.25(0.246)}$

PIN 1 ID

PIN 1

0.65(0.0256)BSC

$\dfrac{7.90(0.311)}{7.70(0.303)}$

1.20(0.047)MAX

$\dfrac{0.15(0.006)}{0.05(0.002)}$

0° ~ 8°

$\dfrac{0.20(0.008)}{0.09(0.004)}$

$\dfrac{0.75(0.030)}{0.45(0.018)}$

04/11/2001

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**24X**, 24-lead (4.4 mm body width) Plastic Thin Shrink Small Outline Package (TSSOP)	24X	A

Revision History

Revision Level – Release Date	History
J – July 2006	Ordering Information tables updated to reflect obsolete parts.